

***Remarks***

Upon entry of the foregoing amendment, claims 14, 18-22, 40, 43-46, 60, and 63-79 are pending in the application, with 14, 40, 63, 70, and 77 being the independent claims. Claims 1-13, 15-17, 23-39, 41, 42, 47-59, 61, and 62 are sought to be cancelled without prejudice to or disclaimer of the subject matter therein. New claims 63-79 are sought to be added. These changes are believed to introduce no new matter, and their entry is respectfully requested.

Claims 40 and 43-46 are claims drawn to a method for assembling a ball grid array package, and are directed essentially to the same inventive concept as claims 14, 18-22, 60, and 63-79. The Examiner restricted claims 40 and 43-46 into a Group II separate from claims 14, 18-22 and 60 (Group I) in the Office Action mailed December 4, 2001. Applicants traversed this restriction of claims 40 and 43-46 in a Reply to Restriction Requirement and Election of Species filed at the USPTO by Applicants on January 4, 2002. Hence, Applicants have not canceled claims 40 and 43-46, and assert that they should be properly included in a single patent application with claims 14, 18-22, 60, and 63-79, as stated in the Reply filed on January 4, 2002.

Prompt and favorable consideration of this Election and Preliminary Amendment is respectfully requested. If the Examiner believes, for any reason, that personal communication

will expedite prosecution of this application, the Examiner is invited to telephone the undersigned at the number provided.

Respectfully submitted,

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Date: 4-29-02

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**Version with markings to show changes made**

Claims 1-13, 15-17, 23-39, 41, 42, 47-59, 61, and 62 are canceled.

19. (Once amended) The package of claim [17] 18, wherein said surface of said cavity shaped portion is plated with solder that allows said stiffener to be surface mounted to at least one soldering pad on the PCB.

New claims 63-79 are added.